

DECLARATION FOR PATENT APPLICATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are stated below next to my name.

I believe that I am the original, first and sole (if only one name is listed below), or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled Interconnect with Low Dielectric Constant Insulators for Semiconductor Integrated Circuit Manufacturing, the specification of which is:

- (X) attached hereto, or  
( ) was filed on \_\_\_\_\_  
as Application Serial No. \_\_\_\_\_  
and was amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56(a).

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application are not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

Application Serial No.	Filing Date	Status
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I hereby appoint the following attorney(s) and/or agents to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

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William C. Cray, Reg. No. 27,627, Philip K. Yu, Reg. No. 35,742, Susie H. Oh, Reg. No. 36,391, Joseph W. King, Jr., Reg. No. 35,768, Raymond Sun, Reg. No. 35,699, and Eric Ho, Reg. No. 39,711, with full power of substitution and revocation hereby given to William C. Cray.

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4311 Jamboree Road  
Newport Beach, CA 92660-3095

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further, that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of inventor 1: Bin Zhao 1-05

Inventor's signature: Bin Zhao Date: 9/11/98

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Inventor's signature: Maureen R. Brongo Date: 9-11-98

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